

FEATURES

- TYPICAL NOISE: 6 NV/VHZ
- LOW CISS: 3.5PF TYPICAL
- HIGH INPUT IMPEDANCE
- REPLACEMENT FOR OTHER 2N3957,8 PARTS

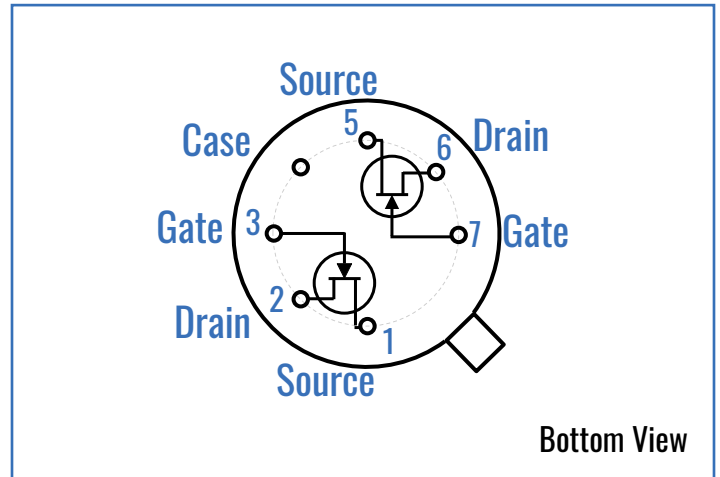
DESCRIPTION

The -50V 2N3957 and 2N3958 matched pair JFET's are targeted for high input impedance applications for mid to high frequency designs.

Gate leakages are typically 10pA at room temperatures. Parts are matched down to 5mV.

The TO-71 package is hermetically sealed and suitable for military applications. Custom specifications, matching, and packaging options are available.

TX, TXV, and S-Level Screening Available - Consult Factory.

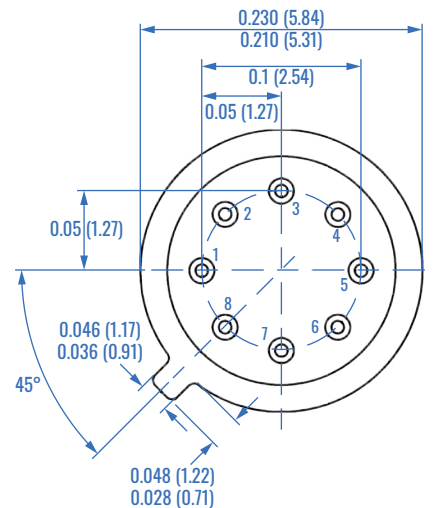
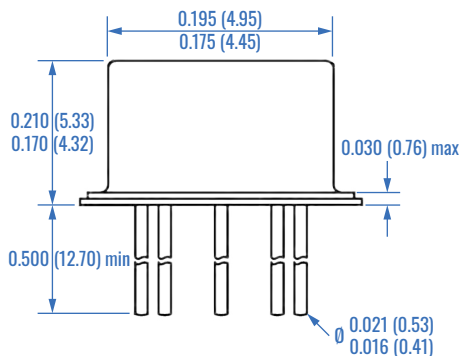


ORDERING GUIDE

Part Number	2N3957, 2N3958
Description	-50V Dual Matched N-Channel JFET

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Reverse Gate Source and Gate Drain Voltage	V_{RGS}	-50	V
Continuous Forward Gate Current	I_{FG}	50	mA
Continuous Device Power Dissipation	P_D	250	mW
Power Derating	P	4.3	mW/°C
Operating Junction Temperature	T_J	-55 to 150	°C
Storage Temperature	T_{STG}	-65 to 175	°C



STATIC CHARACTERISTICS

Typical @ 25°C unless otherwise noted.

Parameter	Symbol	2N3957, 2N3958			Unit
		Min.	Typ.	Max.	
Gate to Source Breakdown Voltage	$V_{DS} = 0V, I_G = -1\mu A$	$V_{(BR)GSS}$	-50		V
Gate to Source Reverse Current	$V_{GS} = -30V, V_{DS} = 0V, T_A = 25^\circ C$ $V_{GS} = -30V, V_{DS} = 0V, T_A = 125^\circ C$	I_{GSS}		-100 -500	pA nA
Gate Operating Current	$V_{DS} = 20V, I_D = 200\mu A, T_A = 25^\circ C$ $V_{DS} = 20V, I_D = 200\mu A, T_A = 125^\circ C$	I_G		-50 -250	pA nA
Gate to Source Cutoff Voltage	$V_{DS} = -20V, I_G = 1nA$	$V_{GS(OFF)}$	-1		V
Gate Source Voltage	$V_{DS} = 20V, I_D = 50\mu A$ $V_{DS} = 20V, I_D = 200\mu A$	V_{GS}	-0.5		V
Gate Source Forward Voltage	$V_{DS} = 0V, I_G = 1nA$	$V_{GS(F)}$		2	V
Drain to Source Saturation Current	$V_{GS} = 0V, V_{DS} = 20V$ (Pulsed)	I_{DSS}	0.5	5	nA

DYNAMIC CHARACTERISTICS

Typical @ 25°C unless otherwise noted.

Parameter	Symbol	2N3957, 2N3958		Unit		
		Min.	Max.			
Forward Transconductance	$V_{DS} = 10V, V_{GS} = 0V, f = 1kHz$ $V_{DS} = 20V, V_{GS} = 0V, f = 200MHz$	G_{FS}	1000 1000	3000	μS	
Output Conductance	$V_{DS} = 20V, f = 1kHz$	G_{OS}		35	μS	
Input Capacitance	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$	C_{iss}		4	pF	
Reverse Capacitance	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$	C_{rss}		1.2	pF	
Noise Figure	$V_{DS} = 20V, f = 10Hz, R_G = 10M\Omega$	NF		0.5	dB	
Differential Gate Current	$V_{DS} = 20V, I_D = 200\mu A, T_A = 125^\circ C$	$ I_{G1} - I_{G2} $		10	nA	
Saturation Drain Current Ratio	$V_{DS} = 20V, V_{GS} = 0V$	2N3957 2N3958	I_{DSS1} / I_{DSS2}	0.90 0.85	1 1	
Differential Gate Source Voltage	$V_{DS} = 20V, I_D = 200\mu A$	2N3957 2N3958	$ V_{GS1} - V_{GS2} $		20 25	mV
Differential Gate Source Voltage with Temperature	$V_{DS} = 20V, I_D = 200\mu A, T_0 = -55^\circ C$ to $125^\circ C$		$\frac{ V_{GS1} - V_{GS2} }{\Delta T}$		5	mV/°C
Transconductance Ratio	$V_{DS} = 20V, I_D = 200\mu A, f = 1kHz$	2N3957 2N3958	g_{fs1} / g_{fs2}	0.90 0.85	1 1	